# Epo-Weld™ HTE-6498



# High Temperature, Superior Strength & Chemical-Resistant Bonder

#### PRODUCT DESCRIPTION

Incure Epo-Weld™ (1:1) is an innovative, high performance, two-component epoxy (sealant and encapsulant) bonding material that offers effective bonding and filling properties on many substrates. Super fast-setting of pot-life of just 3 mins, bonding strength starts increasing after 15 mins and full cure within 72hrs at room temperature. Incure 6498 cures to a high gloss clear surface encapsulant with exceptional high temperature and chemical resistance. An excellent choice for use without curing equipment where speed of cure is desired. Complies to 2011/65/EU RoHS regulations.

### **UNCURED PROPERTIES**

Chemical Type	Epoxy, 100% Solids, No Solvents				
Appearance	Two Part Component, Clear Transparent				
Density, g/ml	1.16	Refractive	e Index	N.A.	@20°C
Flash Point, °C	>150 Toxicity Very Low (Refer to MSDS)				SDS)
Viscosity, cP	11,000 -	1,000 - 18,000 @20rpm			6
Other viscosities are a viscosity range requesthis product may be p Email us at: support@local distributor for mo	offering, b fee.	ASTM	D2556		

<sup>&</sup>lt;sup>1</sup> Viscosity (cP) taken at 25°C - Call to enquiry for other viscosities

#### **CURED PROPERTIES**

CONED I NOI ENTIEC					
Shore Hardness, Durometer		D79 to D89	ASTM 2240		
Linear Shrinkage / Expansion (-ve)		0.05%	ASTM D2566		
Water Absorption at 2	Water Absorption at 24hrs		<sup>2</sup> ISTM D570		
Tensile (PSI)	PC-PC / SS-SS	1,600* / 5,600*	ASTM 638		
* PC-PC / SS-SS / S-S / AL-AL * PC Substrate Failure	S-S / AL-AL	9,400* / 3,600*	ASTIVI 036		
Surface After Full Cui	Surface After Full Cure		<sup>2</sup> ISTM D189		
Elongation at Break		26%	ASTM 638		
Thermal Range (Brittleness / Degrades) °C		-55 to 175	<sup>2</sup> ISTM D366		
Young's Modulus of Elasticity, MPa (PSI)		876 (127,000)	3 ASTM 638		
Linear CTE (α1 & α2), ppm/°C		Not Available	<sup>2</sup> ISTM D696		
A PC Substrate Failure Surface After Full Cui Elongation at Break Thermal Range (Britt Young's Modulus of E	S-S / AL-AL Surface After Full Cure Elongation at Break Thermal Range (Brittleness / Degrades) °C Young's Modulus of Elasticity, MPa (PSI)		<sup>2</sup> ISTM D189 ASTM 638 <sup>2</sup> ISTM D366 <sup>3</sup> ASTM 638		

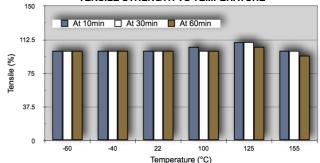
<sup>&</sup>lt;sup>2</sup> ISTM - refers to Incure Standard Test Method

#### RECOMMENDED UV CURE SCHEDULE (FULL CURE)

Full Cure Exposure Time			UVA	UVB	UVC	UVV
Fixture Time between glass slides		mW/cm <sup>2</sup>				
Exposure Time (s)	0.0	mJ/cm <sup>2</sup>	0	0	0	0
F200P™ @3.75" Dist	0.0	mW/cm <sup>2</sup>				
Belt Speed (ft/min)	N.A.	mJ/cm <sup>2</sup>	0	0	0	0
F500™ @3.0" Dist	TBA	mW/cm <sup>2</sup>				
Belt Speed (ft/min)	N.A.	mJ/cm <sup>2</sup>	0	0	0	0
S20™ Spot (4-Pole LG) 0.4" Dist		mW/cm <sup>2</sup>				
Exposure Time (s)	TBA	mJ/cm <sup>2</sup>	0	0	0	0
L9000™ LED Spot @ 0.67" Dist		mW/cm <sup>2</sup>				
Exposure Time (s)	TBA	mJ/cm <sup>2</sup>	0	0	0	0

Cure times on 8mm ø adhesive sample. Belt speeds using C9000-F200Px1AB (Flood) and C9000-F500x1AC (Focused Beam) conveyors for area curing. Please consult IncureLab™ for any other requirer

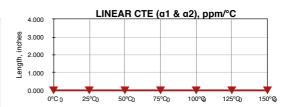
#### TENSILE STRENGTH VS TEMPERATURE



## **UV INTENSITY REFERENCE TABLE**

Incure UV Curing Lamp Model	<sup>4</sup> Curing Distance vs UV Intensity					
Spot Curing (Diameter)	0.5" (12.6)	1" (25.4)	1.5" (38)	2" (50.8)	2.5" (63.5)	3" (76.2)
S20™ ARC (mW/cm²) / (ø mm)	1,400 (3)	1,500 (4)	650 (6)	360 (8)	240 (10)	175 (12)
L9000™ LED (mW/cm²) / (ø mm)	7,500 (9)	5,000 (10)	2,300 (17)	1,200 (20)	700 (25)	450 (30)
Flood/Focus Beam (Area)	UV Intensity (mW/cm²)					
F200™ ARC Flood (6" x 8")	325	280	245	215	190	165
F400™ ARC Flood (4" x 4")	860	570	440	345	270	215
F500™ ARC Focused (3" x 5")	1,040	685	530	415	325	260
L1044-365™ LED Flood (4" x 4")	2,675	2,380	1,900	1,625	1,430	1,280
L1044-405™ LED Flood (4" x 4")	2,950	2,625	2,150	1,900	1,650	1,450

<sup>4</sup> Curing Distance is defined by the tip of light-guide or base of lamp housing to the bond area. All values are nominal with ±10% n, with LED Flood Static Uniformity at ±78% and Dynamic Uniformity at ±90%. Recommended curing parameters in grey



#### SECONDARY HEAT CURE SCHEDULE

Continuous Oven Bake	Duration		
95°C (203°F)	120 mins		
110°C (230°F)	60 mins		
125°C (257°F)	30 mins		

UV CURING SCHEDULE FOR THIS PRODUCT (Not Applicable for this Product)

Wavength λ	UVA (320 - 400nm)	UVB (290-320nm)	UVC (290-220nm)	VUV (400-700nm)
Minimum Intensity	N.A. mW/cm <sup>2</sup>	N.A. mW/cm <sup>2</sup>	N.A. mW/cm <sup>2</sup>	N.A. mW/cm <sup>2</sup>
Total Energy Required	N.A. mJ/cm <sup>2</sup>	N.A. mJ/cm <sup>2</sup>	N.A. mJ/cm <sup>2</sup>	N.A. mJ/cm <sup>2</sup>

Note: This product has been thoroughly tested to cure with F200P™ UV Flood Lamp. Intensity wavelengths (shaded) are crucial for curing this product. All measurements are made with EIT UV PowerPuck II. If you are unable to fully cure this product for some reasons, pls email us for assistance with your curing information

## SHELF-LIFE, STORAGE, USE AND HANDLING OF THIS PRODUCT

Shelf-Life of this unopened product is a minimum of SIX (6) months from date of manufacture. Avoid direct exposure of bottle to visible light at all times. Containers should remained covered when not in use. Product should be stored in a dark cool place of 10°C to 32°C. Transfer of product into other packages void all warranties. Users should ensure all bonding surfaces are free of grease, mold release, or any contaminants, as bonding performance will be compromised. All tests for cured bonds should be carried out at ambient temperature. For safe handling of this product, please read Material Safety Data-sheet (MSDS) prior to use. Organic solvents, such as IPA, may be used to wipe away uncured material from surfaces.

### EtO and GAMMA STERILIZATION (Not Applicable for this Product)

All Incure medical products are formulated to subject to standard sterilization methods, such as EtO and Gamma Radiation of 25 to 50 kGrays (cumulative). Enhanced moisture and thermal resistance of this product show excellent adhesion and bonding strength after one cycle of steam auto-clave test. Depending on bond design and structure of the application, users should test specific assemblies after subjecting them to sterilisation. Consult Incure Support Team for assistance, if your devices are subjected to more than one sterilisation cycles.

#### NOTE

The data contained in this document are furnished for information only. We cannot assume responsibility for the results obtained by others over whose methods we have no control. It is the user's responsibility to determine suitability for the user's purpose of any production methods mentioned herein. INCURE will not be liable for any indirect, special, incidental or consequential loss or damage arising from this INCURE product, regardless of the legal theory asserted. INCURE recommends that each user adequately test its proposed use and application before repetitive use, using this data as a guide.

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<sup>&</sup>lt;sup>3</sup> ASTM 638 Young's Modulus test speed @5mm/min for rigid and semi-rigid materials, @50mm/min for non-rigid materials, unless otherwise specified.